

CDC913
PC MOTHERBOARD CLOCK GENERATOR
WITH DUAL 1-TO-4 BUFFERS AND 3-STATE OUTPUTS

SCAS502C – APRIL 1995 – REVISED MAY 1996

Function Tables

SEL0	SEL1	X1	CPUCLK	PCICLK	REFCLK
L	L	14.318 MHz	50 MHz	33 MHz	14.318 MHz
H	L	14.318 MHz	60 MHz	33 MHz	14.318 MHz
L	H	14.318 MHz	66 MHz	33 MHz	14.318 MHz
H	H	TCLK†	TCLK†	TCLK†	TCLK†

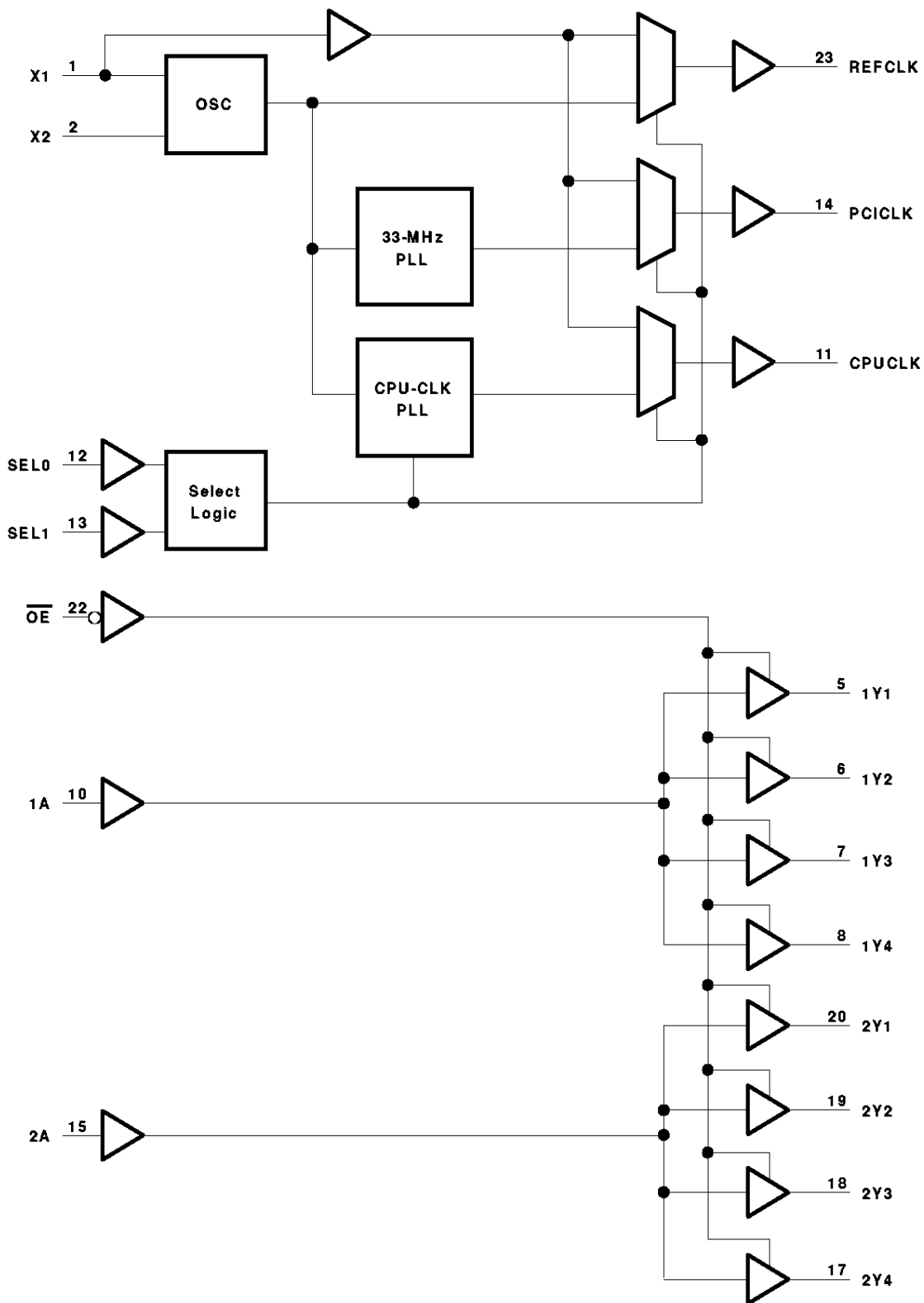
† Test clock (TCLK) is driven over X1 when the CDC913 is in the TEST mode; i.e., SEL1 = SEL0 = H.

\overline{OE}	1A	2A	1Yn	2Yn
H	X	X	Hi-Z	Hi-Z
L	L	L	L	L
L	L	H	L	H
L	H	L	H	L
L	H	H	H	H



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functional block diagram



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	-0.5 V to 4.6 V
Input voltage range, V_I (see Note 1)	-0.5 V to 4.6 V
Voltage range applied to any output in the high state or power-off state, V_O	-0.5 V to $V_{CC} + 0.5$ V
Current into any output in the low state, I_O	$2 \times I_{OHmax}$
Input clamp current, I_{IK} ($V_I < 0$)	-18 mA
Output clamp current, I_{OK} ($V_O < 0$)	-50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2): DB package	0.65 W
..... DW package	1.7 W
Storage temperature range, T_{stg}	-65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002.

recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
V_{CC}	Supply voltage	3.135	3.6	V
V_{IH}	High-level input voltage	2		V
V_{IL}	Low-level input voltage		0.8	V
V_I	Input voltage	0	V_{CC}	V
I_{OH}	High-level output current	REFCLK	-12	mA
		PCICLK	-6	
		CPUCLK	-6	
		1Yn	-12	
		2Yn	-12	
I_{OL}	Low-level output current	REFCLK	12	mA
		PCICLK	6	
		CPUCLK	6	
		1Yn	12	
		2Yn	12	
T_A	Operating free-air temperature	0	70	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		T _A = 25°C			UNIT	
			MIN	TYP†	MAX		
V _{IK}	V _{CC} = 3.135 V,	I _I = -18 mA			-1.2	V	
V _{OH}	V _{CC} = 3.135 V	I _{OH} = -12 mA	REFCLK	2.5	2.4	V	
		I _{OH} = -6 mA	PCICLK	2.5	2.4		
		I _{OH} = -6 mA	CPUCLK	2.5	2.4		
		I _{OH} = -12 mA	1Yn	2.5	2.4		
		I _{OH} = -12 mA	2Yn	2.5	2.4		
V _{OL}	V _{CC} = 3.135 V	I _{OL} = 12 mA	REFCLK		0.4	0.5	V
		I _{OL} = 6 mA	PCICLK		0.4	0.5	
		I _{OL} = 6 mA	CPUCLK		0.4	0.5	
		I _{OL} = 12 mA	1Yn		0.4	0.5	
		I _{OL} = 12 mA	2Yn		0.4	0.5	
I _I	V _{CC} = 3.6 V,	V _I = V _{CC} or GND			±1	±1	μA
I _{OZ}	V _{CC} = 3.6 V,	V _O = 3 V or 0			±1	±1	μA
I _{CC}	V _{CC} = 3.6 V, V _I = V _{CC} or GND	I _O = 0,	Outputs high			1	mA
			Outputs low			1	
			Outputs disabled			1	
C _i	V _I = 3.135 V or 0					6	pF
C _o	V _I = 3.135 V or 0					6	pF

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

timing requirements over recommended ranges of supply voltage and operating free-air temperature

		MIN	MAX	UNIT
Stabilization time‡	After SEL1, SEL0		5	ms
	After power up		5	

‡ Time required for the integrated PLL circuit to obtain phase lock of its feedback signal to its reference signal. For phase lock to be obtained, a fixed-frequency, fixed-phase reference signal must be present at X1. Until phase lock is obtained, the specifications for propagation delay and skew parameters given in the switching characteristics table are not applicable.



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switching characteristics (see Figures 1 and 2)

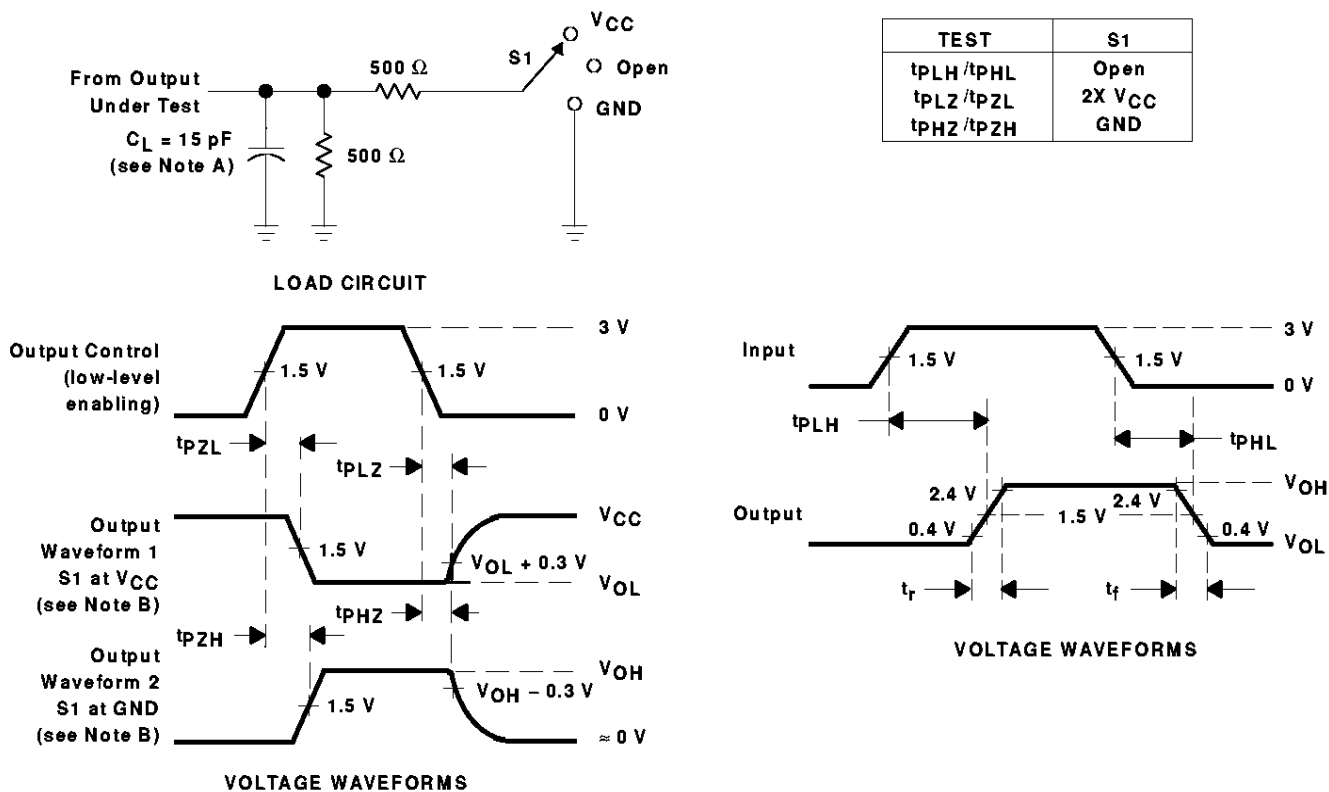
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 3.3 V, T _A = 25°C			V _{CC} = 3.135 V to 3.6 V, T _A = 0°C to 70°C		UNIT
			MIN	TYP	MAX	MIN	MAX	
t _{PLH}	1A	1Yn	1.5	3.5		1.2	3.8	ns
	2A	2Yn	1.5	3.5		1.2	3.8	
t _{PHL}	1A	1Yn	1.5	3.5		1.2	3.8	ns
	2A	2Yn	1.5	3.5		1.2	3.8	
t _{PZH}	\overline{OE}	1Yn	2.5	7		2	7.5	ns
		2Yn	2.5	7		2	7.5	
t _{PZL}	\overline{OE}	1Yn	2.5	7		2	7.5	ns
		2Yn	2.5	7		2	7.5	
t _{PHZ}	\overline{OE}	1Yn	2.5	7		2	7.5	ns
		2Yn	2.5	7		2	7.5	
t _{PLZ}	\overline{OE}	1Yn	2.5	7		2	7.5	ns
		2Yn	2.5	7		2	7.5	
t _{sk(o)}		1Yn			350		350	ps
		2Yn			350		350	
		Any Y			500		500	
t _{sk(p)}		1Yn and 2Yn			1		1	ns
Jitter _(pk-pk) [†]		GPUCLK					±250	ps
		PCICLK					±350	
t _{c(period)} [†]		PCICLK				30		ns
		GPUCLK	SEL0 = L, SEL1 = L			20		
			SEL0 = H, SEL1 = L			16.7		
			SEL0 = L, SEL1 = H			15		
Duty cycle [†]		GPUCLK				45%	55%	
		PCICLK				45%	55%	
t _r [‡]							2	ns
t _f [‡]							2	ns

[†] Specifications are applicable only after the PLL stabilization time has elapsed.

[‡] Rise and fall times are characterized using the load circuits shown in Figure 1.



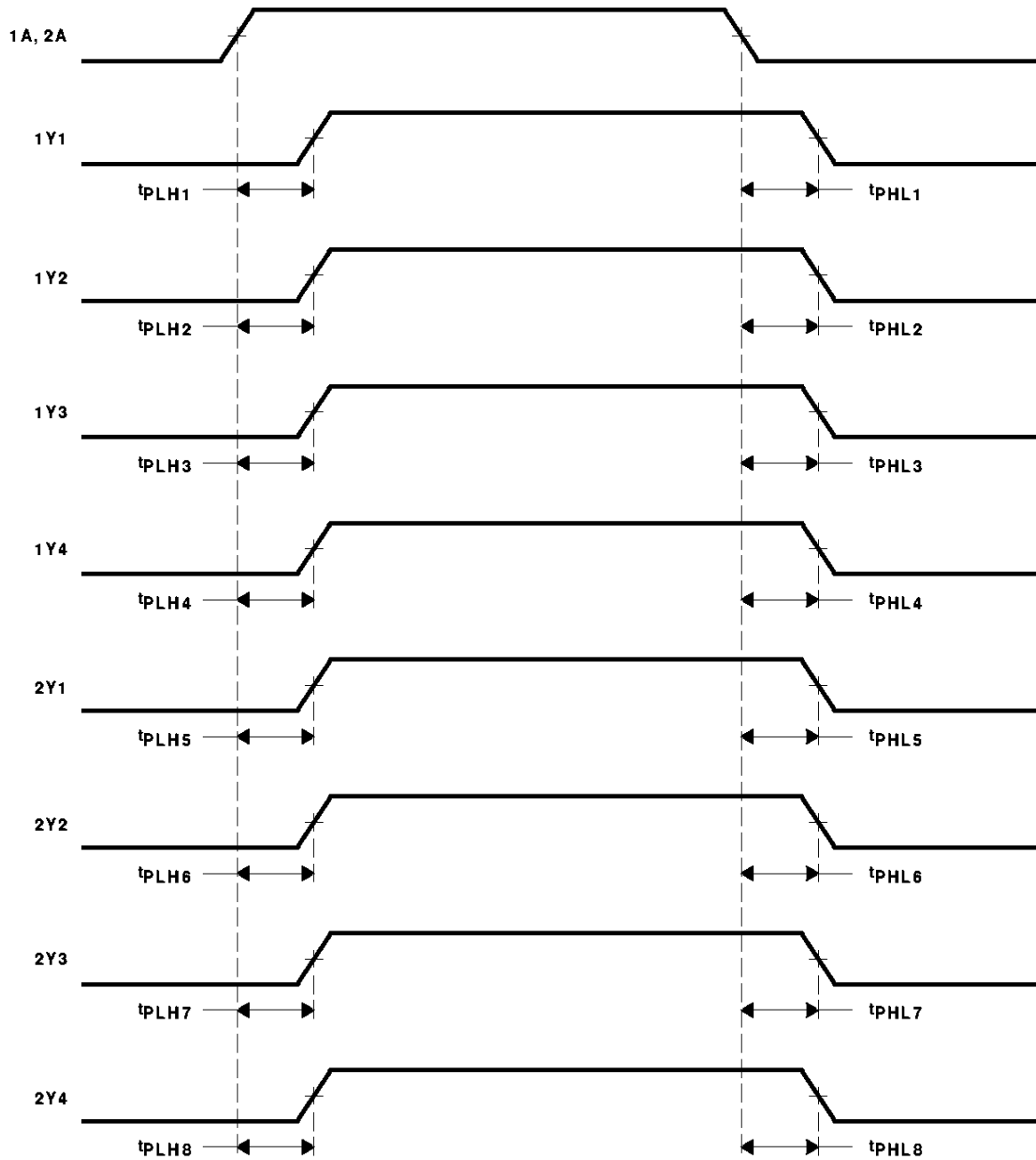
PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r \leq 2.5$ ns, $t_f \leq 2.5$ ns.
 D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION



NOTE A: Output skew, $t_{sk(o)}$, is calculated as the greater of:
 The difference between the fastest and slowest of t_{PLHn} ($n = 1, 2, \dots, 8$).
 The difference between the fastest and slowest of t_{PHLn} ($n = 1, 2, \dots, 8$).
 Pulse skew, $t_{sk(p)}$, is calculated as the greater of $|t_{PLHn} - t_{PHLn}|$ ($n = 1, 2, \dots, 8$).

Figure 2. Waveforms for Calculation of $t_{sk(o)}$ and $t_{sk(p)}$

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